Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A method of producing a thin film by plasma CVD on an inner wall surface of a substrate facing a space formed in said substrate, substrate, said substrate having a substantially tubular structure, said method comprising the steps of:

providing said substrate in a chamber for plasma CVD; and

flowing a gas for plasma reaction into said space over said inner wall surface and applying a pulse voltage from a high voltage pulse source on said substrate without substantially applying a direct-DC bias voltage from a direct current-source on said substrate to form said thin film on said inner wall surface.

- 2. (Original) The method of claim 1, wherein a difference of a pressure is generated in the longitudinal direction of said substrate.
- 3. (Original) The method of claim 1, wherein said substrate has one opening therein communicating with said space.
- 4. (Original) The method of claim 1, wherein said thin film comprises diamond or diamond like carbon.
- 5. (Withdrawn) A system for producing a thin film by plasma CVD on an inner wall surface of a substrate facing a space formed in said substrate, said system comprising:
 - a chamber for plasma CVD and for containing said substrate;
 - a supply hole for supplying a gas for plasma reaction into said chamber; and a means for applying a pulse voltage on said substrate,
 - wherein said gas is flown into said space and said means applies a pulse

voltage on said substrate without substantially applying a direct bias voltage on said substrate

to form said thin film on said inner wall surface.

- 6. (Withdrawn) The system of claim 5, further comprising a means for generating a difference of a pressure in the longitudinal direction of said substrate.
- 7. (Withdrawn) The system of claim 5, wherein said substrate has one opening therein communicating with said space.
- 8. (Withdrawn) The system of claim 5, wherein said thin film comprises diamond or diamond like carbon.
- 9. (Previously Presented) The method of claim 1, applying the pulse voltage being performed without accelerating ions.